

VLN002-9S8EA

2.5W Audio Power Amplifier

Version 1.01

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Revision History

Version	Date	Description	Modified Page		
1.0	2014/04/16	New release.	-		

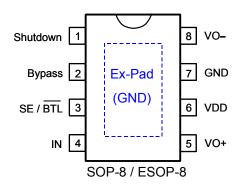
1. GENERAL DESCRIPTION

The VLN002-9S8EA are mono audio power amplifier CMOS ICs. They are designed by LSI high technology with a low-power and low-cost process. Less peripheral components are required in application. VLN002-9S8EA is a Bridge-Tied Load (BTL) or a Single-Ended (SE) power amplifier with headphone support. It is capable of delivering 2.5W of average power to a 4Ω load or 3.0W of average power to a 3Ω load with less than 10% distortion (THD+N) from a 5V power supply.

2. FEATURES

- (1). Wide operating voltage range: $V_{DD} = 1.8V \sim 6.8V$.
- (2). VLN002-9S8EA: Bridge-Tied Load (BTL) or Single-Ended (SE) modes operation.
- (3). High output power: P_{OUT} is 2.5W for V_{DD} = 5V, Load =4 Ω , f = 1kHz and THD+N = 10%.
- (4). Low standby (shutdown) current. (Typ.=0.1uA)
- (5). No output coupling capacitors, snubber networks or bootstrap capacitors required.
- (6). BTL output can directly drive capacitive loads such like piezo-buzzer.
- (7). Built-in auto Ramp-up/ Ramp-down circuit to minimize the turn-on and turn-off pop noise. The time of Ramp-up/ Ramp-down can be adjusted by C_b bypass capacitor.
- (8). Built-in Thermal Shutdown (TSD).
- (9). High 5KV Human Body Mode (HBM) ESD protection.
- (10). ESOP-8 package type is available.

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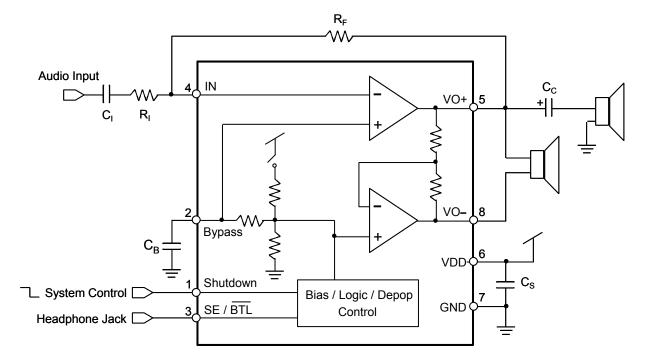


: Exposed pad for ESOP-8 only. Must be connected to PCB ground plane for heat dissipation.



3. BLOCK DIAGRAM

3.1 VLN002-9S8EA



4. PIN DESCRIPTION

4.1 VLN002-9S8EA

Pin #	Pin Name	ATTR.	Description			
1	Shutdown	I	Active high input to disable VLN002-9S8EA operation.			
2	Bypass	I	Mid-supply bias at VDD/2 with an external 0.1uF ~ 1.0uF capacitor.			
3	SE / BTL	I	When this input is high, VLN002-9S8EA is in SE mode. When this input is low, VLN002-9S8EA is in BTL mode.			
4	IN	I	Inverting input.			
5	VO+	0	Positive BTL output.			
6	VDD	Power	Power input.			
7	GND	Power	Ground reference.			
8	VO-	0	Negative BTL output.			
9	Ex-Pad	Power	Exposed pad for thermal tab, must be connected to GND.			

5. ELECTRICAL CHARACTERISTICS

5.1 Absolute Maximum Rating

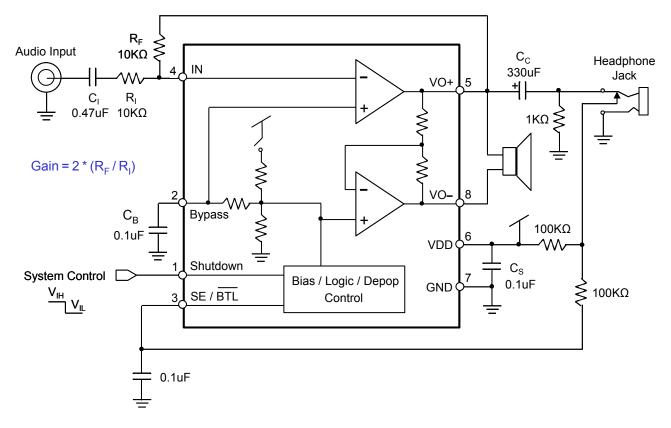
Symbol	Parameter		Rating	Unit		
V_{DD} - V_{SS}	Supply volta	ge	-0.5 ~ +7.0	V		
V _{IN}	Input voltag	е	V_{SS} -0.3V ~ V_{DD} +0.3	V		
Δ	Thermal resistance	SOP-8	150	°C/W		
Θ_{JA}	(Junction to Ambient)	ESOP-8	60	C/VV		
D	Dewer dissinction	SOP-8 1.0		W		
P _D	Power dissipation	ESOP-8	ESOP-8 2.5			
T _A	Operating ambient te	mperature	-40 ~ +85	С°		
TJ	Operating junction te	mperature	+170	С°		
T _{ST}	Storage temper	ature	-55 ~ +170	°C		

5.2 DC Characteristics (VDD=5.0V, TA=25°C, unless otherwise specified)

Symbol	Parameter		Min.	Тур.	Max.	Unit	Condition		
V _{DD}	Operating v	Operating voltage			6.8	V			
I _{SB}	Standby (Shutdown) current			0.1	1	uA	Shutdown is enabled.		
	Operating current	V_{DD} = 3.0V		1.6		mA			
	(BTL mode)	V _{DD} = 5.0V		2.0		mA	No load		
I _{OP}	Operating current	V _{DD} = 3.0V		0.9		mA	NO IOAU		
	(SE mode)	V _{DD} = 5.0V		1.2		mA			
	-			0.1		%	$R_{L} = 4\Omega, P_{OUT} = 1.0W$		
THD+N	Total harmonic dist	ortion + noise		0.1		%	R _L = 8Ω, P _{OUT} = 1.0W		
	Signal to Noi	a ratio		100		dB	$R_{L} = 4\Omega, P_{OUT} = 1.6W$		
SNR	Signal-to-Nois			102		dB	R _L = 8Ω, P _{OUT} = 1.0W		
	Output power (f = 1kHz)	R _L = 4Ω		2.0		W	THD+N = 1%		
Р				2.5		W	THD+N = 10%		
P _{OUT}		D = 00		1.3		W	THD+N = 1%		
		R _L = 8Ω		1.6		W	THD+N = 10%		
V _{os}	Output offset voltage			6	30	mV	V _{IN} = 0V		
PSRR	Power supply rejection ratio			70		dB	f=1kHz		
	Wakeup time (BTL mode)			63		ms	$C_B = 0.1 \mu F$		
–				100		ms	$C_{B} = 0.47 \mu F$		
T _{ON}	Wakeup		70		ms	$C_B = 0.1 \mu F$			
	(SE mod		145		ms	$C_{B} = 0.47 \mu F$			
	Shutdown		5		ms	$C_B = 0.1 \mu F$			
 _	(BTL mo		37		ms	$C_{B} = 0.47 \mu F$			
T _{OFF}	Shutdown		25		ms	$C_B = 0.1 \mu F$			
	(SE mod		160		ms	$C_{B} = 0.47 \mu F$			

6. APPLICATION CIRCUIT

6.1 VLN002-9S8EA Typical Application



7. PACKAGE DIMENSION

7.1 8-Pin Plastic ESOP with Exposed Pad (150 mil)

	INCHES			MILLIMETERS			
		MIN	TYP	MAX	MIN	TYP	MAX
	А	0.183	-	0.202	4.65	-	5.13
	В	0.144	0.150	0.163	3.66	3.81	4.14
B1 B P	С	0.068	-	0.074	1.35	-	1.88
	D	0.010	-	0.020	0.25	-	0.51
Exposed Pad	F	0.015	-	0.035	0.38	-	0.89
	G	0.050 BSC		1.27 BSC			
	J	0.007	-	0.010	0.19	-	0.25
	К	0.005	-	0.010	0.13	-	0.25
SEATING PLAN K	L	0.189	-	0.205	4.80	-	5.21
	М	-	-	8°	-	-	8°
	Ρ	0.228	-	0.244	5.79	-	6.20
	A1	0.077		0.090	1.95	-	2.28
Note: For 8-pin ESOP IC, 100 units per tube.	B1	0.077		0.090	1.95	-	2.28



8. ORDERING INFORMATION

P/N	Shipping Type	Remarks
VLN002-9S8EA	ESOP-8	Width 150 mil.